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| APPLICATION NO.   | FILING DATE | FIRST NAMED INVENTOR | ATTORNEY DOCKET NO.   | CONFIRMATION NO. |
|---|-------------|----------------------|-----------------------|------------------|
| 10/821,100  | 04/07/2004  | Zhong Dong           | M-15295 US            | 8965             |
| 32605 7590 01/26/2007<br>MACPHERSON KWOK CHEN & HEID LLP<br>2033 GATEWAY PLACE<br>SUITE 400<br>SAN JOSE, CA 95110 |             |                      | EXAMINER<br>VU, DAVID |                  |
|   |             |                      | ART UNIT<br>2818      | PAPER NUMBER     |
| SHORTENED STATUTORY PERIOD OF RESPONSE  |             | MAIL DATE            | DELIVERY MODE         |                  |
| 3 MONTHS  |             | 01/26/2007           | PAPER                 |                  |

**Please find below and/or attached an Office communication concerning this application or proceeding.**

If NO period for reply is specified above, the maximum statutory period will apply and will expire 6 MONTHS from the mailing date of this communication.

|                              |                                      |                                    |  |
|------------------------------|--------------------------------------|------------------------------------|--|
| <b>Office Action Summary</b> | <b>Application No.</b><br>10/821,100 | <b>Applicant(s)</b><br>DONG ET AL. |  |
|                              | <b>Examiner</b><br>DAVID VU          | <b>Art Unit</b><br>2818            |  |

-- The MAILING DATE of this communication appears on the cover sheet with the correspondence address --

### Period for Reply

A SHORTENED STATUTORY PERIOD FOR REPLY IS SET TO EXPIRE 3 MONTH(S) FROM THE MAILING DATE OF THIS COMMUNICATION.

- Extensions of time may be available under the provisions of 37 CFR 1.136(a). In no event, however, may a reply be timely filed after SIX (6) MONTHS from the mailing date of this communication.
- If the period for reply specified above is less than thirty (30) days, a reply within the statutory minimum of thirty (30) days will be considered timely.
- If NO period for reply is specified above, the maximum statutory period will apply and will expire SIX (6) MONTHS from the mailing date of this communication.
- Failure to reply within the set or extended period for reply will, by statute, cause the application to become ABANDONED (35 U.S.C. § 133). Any reply received by the Office later than three months after the mailing date of this communication, even if timely filed, may reduce any earned patent term adjustment. See 37 CFR 1.704(b).

### Status

- 1) ☒ Responsive to communication(s) filed on 07 November 2006.
- 2a) ☐ This action is **FINAL**.                      2b) ☒ This action is non-final.
- 3) ☐ Since this application is in condition for allowance except for formal matters, prosecution as to the merits is closed in accordance with the practice under *Ex parte Quayle*, 1935 C.D. 11, 453 O.G. 213.

### Disposition of Claims

- 4) ☒ Claim(s) 1-15 and 21-28 is/are pending in the application.
- 4a) Of the above claim(s) \_\_\_\_\_ is/are withdrawn from consideration.
- 5) ☐ Claim(s) \_\_\_\_\_ is/are allowed.
- 6) ☒ Claim(s) 1-15 and 21-28 is/are rejected.
- 7) ☐ Claim(s) \_\_\_\_\_ is/are objected to.
- 8) ☐ Claim(s) \_\_\_\_\_ are subject to restriction and/or election requirement.

### Application Papers

- 9) ☐ The specification is objected to by the Examiner.
- 10) ☒ The drawing(s) filed on 07 April 2004 is/are: a) ☒ accepted or b) ☐ objected to by the Examiner.  
Applicant may not request that any objection to the drawing(s) be held in abeyance. See 37 CFR 1.85(a).  
Replacement drawing sheet(s) including the correction is required if the drawing(s) is objected to. See 37 CFR 1.121(d).
- 11) ☐ The oath or declaration is objected to by the Examiner. Note the attached Office Action or form PTO-152.

### Priority under 35 U.S.C. § 119

- 12) ☐ Acknowledgment is made of a claim for foreign priority under 35 U.S.C. § 119(a)-(d) or (f).
- a) ☐ All    b) ☐ Some \*    c) ☐ None of:
1. ☐ Certified copies of the priority documents have been received.
2. ☐ Certified copies of the priority documents have been received in Application No. \_\_\_\_\_.
3. ☐ Copies of the certified copies of the priority documents have been received in this National Stage application from the International Bureau (PCT Rule 17.2(a)).
- \* See the attached detailed Office action for a list of the certified copies not received.

### Attachment(s)

- |  |   |
|--|---|
| 1) <input type="checkbox"/> Notice of References Cited (PTO-892)   | 4) <input type="checkbox"/> Interview Summary (PTO-413)<br>Paper No(s)/Mail Date. _____ |
| 2) <input type="checkbox"/> Notice of Draftsperson's Patent Drawing Review (PTO-948)                                   | 5) <input type="checkbox"/> Notice of Informal Patent Application (PTO-152)             |
| 3) <input type="checkbox"/> Information Disclosure Statement(s) (PTO-1449 or PTO/SB/08)<br>Paper No(s)/Mail Date _____ | 6) <input type="checkbox"/> Other: _____  |

## DETAILED ACTION

### Continued Examination Under 37 CFR 1.914

1. A request for continued examination under 37 CFR 1.114, including the, fee set forth in 37 CFR 1.17(e), was filed in this application after final rejection. Since this application is eligible for continued examination under 37 CFR 1.114, and the fee set forth in 37 CFR 1.17(e) has been timely paid, the finality of the previous Office action has been withdrawn pursuant to 37 CFR 1.114. Applicant's submission filed on 11/07/06 has been entered.

### Claim Rejections - 35 USC § 112

The following is a quotation of the first paragraph of 35 U.S.C. 112:

The specification shall contain a written description of the invention, and of the manner and process of making and using it, in such full, clear, concise, and exact terms as to enable any person skilled in the art to which it pertains, or with which it is most nearly connected, to make and use the same and shall set forth the best mode contemplated by the inventor of carrying out his invention.

2. Claims 11, 26 and 27 are rejected under 35 U.S.C. 112, first paragraph, as failing to comply with the written description requirement. The claim(s) contains subject matter which was not described in the specification in such a way as to reasonably convey to one skilled in the relevant art that the inventor(s), at the time the application was filed, had possession of the claimed invention. The original disclosure does not include teaching "ONO-type memory cell stack does not include a metal silicide layer" (**claim 11**); "...flowing the molecular hydrogen (H<sub>2</sub>) towards the stack is constrained to below a volumetric flow ratio of H<sub>2</sub> to O<sub>2</sub> at which

Art Unit: 2818

formation of a hydrogen flame due to the presence of H<sub>2</sub> is at least unstable if not that the flame is extinguish or unignited due to insufficient presence of H<sub>2</sub>” (**claim 26**); and “....flowing the molecular hydrogen (H<sub>2</sub>) towards the stack is constrained to below a volumetric flow ratio of H<sub>2</sub> to O<sub>2</sub> at which stable ignited of a hydrogen flame due to the presence of H<sub>2</sub> is assured on a mass production basis (**claim 27**).

### **Claim Rejections - 35 USC § 103**

The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness rejections set forth in this Office action:

(a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the invention was made to a person having ordinary skill in the art to which said subject matter pertains. Patentability shall not be negated by the manner in which the invention was made.

This application currently names joint inventors. In considering patentability of the claims under 35 U.S.C. 103(a), the examiner presumes that the subject matter of the various claims was commonly owned at the time any inventions covered therein were made absent any evidence to the contrary. Applicant is advised of the obligation under 37 CFR 1.56 to point out the inventor and invention dates of each claim that was not commonly owned at the time a later invention was made in order for the examiner to consider the applicability of 35 U.S.C. 103(c) and potential 35 U.S.C. 102(e), (f) or (g) prior art under 35 U.S.C. 103(a).

3. Claims 1-15 and 21-24 are rejected under 35 U.S.C. 103 (a) as being unpatentable over You et al. (US Pat. 6,706,613, hereinafter You) in view of Wang et al. (US 2005/0110102, hereinafter Wang).

Regarding claims 1-8, 10,11, 15 and 21-24, You discloses in figs. 2B-2C a method of forming sidewall dielectric on an ONO-type memory cell stack where at least one sidewall of the ONO-type memory cell stack 108 includes a plurality of exposed material layers respectively composed of an oxide 105a and an oxidizable material (nitride layer 106a) disposed adjacent to the oxide 105a, the method comprising subjecting the sidewall 120a to a thermal oxide process to form a sidewall oxide (fig. 2C and col. 5, lines 29-37) and forming an supplemental nitride sidewall dielectric after the rapid oxidation process (col. 7, lines 58-67).

You fails to disclose forming the sidewall oxide layer by hydrogen and oxygen. However, Wang teaches that the sidewall oxide layer is formed by a dry ISSG process at a temperature is about 800-1000°C, the flow rate of  $H_2+O_2$  is about 1slm –40slm {See [0032]; [0038] and [0041]}, the pressure is about 1-20 Torr, the duration is about 30-120 seconds [0046]; the ratio of  $H_2/H_2+O_2$  is in the range about 0.1%-40%, therefore, the ratio  $H_2: O_2$  is about 0.01 (Let x be  $H_2$ , y be  $O_2$ ;  $x+y = 100\% = 1$  and  $x/(x+y) = 0.1$ ; we got  $x:y = 0.01$ ). It would have been obvious to one with ordinary skill in the art at the time of the invention to form an oxide film by using a dry ISSG process as taught by Wang in the process of You. As recognized by one skilled in the art, a dry ISSG process provides excellent thickness control and the thermal budget can be reduced (Abstract).

Note that the dry ISSG process is often described as a process generates short lived oxygen radicals {See Xing et al. (US 20030124873) ([0026]-[0038]) for evidence of the state of the art in which atomic oxygen is created by an ISSG process}. Furthermore, the ISSG process of You and Wang meet the structural and methodological limitations of this claim, thus they would (as an obvious consequence) also exhibit the same functional characteristics (i.e. generates

Art Unit: 2818

short lived oxygen radicals whose reactivity extinguishes before the short lived oxygen radicals are able to permeate as deep into the ONO-type memory cell stack and oxidize materials therein as would the reactive oxygen of a High Temperature Oxidation (HTO) process applied to an essentially same ONO-type memory cell stack).

Regarding claim 9, You discloses exposed material layers of the ONO-type memory cell stack includes: a first silicon nitride layer 106a; a first silicon layer (floating gate 104); and a first silicon oxide layer 105a adjacent to the first silicon layer 104 (fig. 2C).

Regarding claim 12, You and Wang fails to disclose a height variation ratio is about 1.20 or less. It would have been obvious to one of ordinary skill in the art at the time the invention was made to modify the combined process of You and Wang by selecting a suitable thickness/height ratio in order to achieve a specific sidewall dielectric, since it has been held that where the general conditions of a claim are disclosed in the prior art, discovering the optimum or working ranges for result effective variables involves only routine skill in the art. *In re Aller*, 220 F.2d 454, 456, 105 USPQ 233, 235 (CCPA 1955). Moreover, the specification contains no disclosure of either the critical nature of the claimed process/device (i.e. - thickness/height ratio) or any unexpected results arising therefrom. Where patentability is said to be based upon particular chosen limitations or upon another variable recited in a claim, the Applicant must show that the chosen limitation are critical. *In re Woodruff*, 919 F.2d 1575, 1578 (Fed. Cir. 1990).

Regarding claims 13 and 14, as recognized by one skilled in the art that a larger erase speed is obtained in a memory cell after formation of the sidewall dielectric by the dry ISSG process {See Fujimoto et al. (US Pat. 6,830,973); col. 7, lines 32-38 and Applicants



Art Unit: 2818

specification, paragraph [0039]}. Note that the ISSG process of You and Wang meet the structural and methodological limitations of this claim, thus they would (as an obvious consequence) also exhibit the same functional characteristics.

### **Allowable Subject Matter**

4. Claims 25 and 28 are objected to as being dependent upon a rejected base claim, but would be allowable if rewritten in independent form including all of the limitations of the base claim and any intervening claims.

### **Response to Arguments**

5. Applicant's arguments with respect to claims 1-15 and 21-23 have been considered but are moot in view of the new ground(s) of rejection.

6. Response to Declaration of Chiliang Chen Traversing Grounds of Rejection Pursuant to 37 C.F.R. §1.132.

Applicant's argues that You '613 "would avoid using a thermal oxidation process that includes hydrogen." However, no where do the You '613 define the process in which the thermal oxidation process is try to avoid using hydrogen. Applicant appears to be merely stating opinion (i.e. "would avoid").

Applicant argues that Wang does not suggest a means for reducing Bird's Beak. However, these arguments are not commensurate with the scope of the claim. Moreover, You et al. teaches "a significant bird's beak is not formed at the ends of the ONO layer 108 during a

Art Unit: 2818

successive oxidation process” (col. 6, lines 15-16). In response to applicant's arguments against the references individually, one cannot show nonobviousness by attacking references individually where the rejections are based on combinations of references. See *In re Keller*, 642 F.2d 413, 208 USPQ 871 (CCPA 1981); *In re Merck & Co.*, 800 F.2d 1091, 231 USPQ 375 (Fed. Cir. 1986). It should be noted that the reason given in the rejection is sufficient motivation to combine You and Wang. The combination of You and Wang discloses a method of forming an oxide film on the ONO sidewall of the memory device by using an ISSG process that includes  $H_2+O_2$ . The ISSG process provides excellent thickness control and the thermal budget can be reduced. Further, USC 103 does not require one reference to specifically mention any aspect of the other reference for a proper combination. Therefore, applicant's arguments are not persuasive, and the rejection is proper.

Applicant's arguments with respect to the use of DCS and  $N_2O$  would prevent the Bird's Beak (paragraph [0041] in the specification). However, this argument is not persuasive since the argument imports limitations from the specification into the claim which importation is expressly prohibited. *In re Morris*, (127 F.3d 1048 (Fed. Cir. 1997)). The examiner notes that Wang also discloses the ISSG including DCS-based nitrides (see Example 5). The ISSG process of You and Wang meet the structural and methodological limitations of this claim, thus they would (as an obvious consequence) also exhibit the same functional characteristics.

### Conclusion

7. Any inquiry concerning this communication or earlier communications from the examiner should be directed to David Vu whose telephone number is (571) 272-1798. The



Art Unit: 2818

examiner can normally be reached on Monday-Friday from 8:00am to 5:00pm. If attempt to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Matthew Smith S can be reached on (571) 272-1907. The fax phone number for the organization where this application or proceeding is assigned is 703-872-9306.

Information regarding the status of an application may be obtained from the Patent Application Information Retrieval (PAIR) system. Status information for published applications may be obtained from either Private PAIR or Public PAIR, Status information for unpublished applications is available through Private PAIR only. For more information about the PAIR system, see <http://pair-direct.uspto.gov>. Should you have questions on access to the Private PAIR system, contact the Electronic Business Center (EBC) at 866-217-9197 (toll-free).



DAVID VU  
PRIMARY EXAMINER